



OUTLINE

The RS5RM Series are CMOS-based step-up DC/DC converter ICs equipped with a voltage regulator (VR) and a voltage detector (VD). Each of these step-up DC/DC converter ICs consists of a PWM DC/DC converter, a linear regulator and a voltage detector. These ICs are output-voltage-fixed type regulators which function as a linear regulator when input voltage is high, and as step-up DC/DC converter+linear regulator when input voltage is low, by using an inductor, a diode and a capacitor as external parts for the ICs.

Since a voltage detector is built in these ICs, the potentials such as the output voltage of DC/DC converters can be monitored.

In addition, these step-up DC/DC converter ICs are suitable for battery-powered and hand-held instruments because internal circuits can be turned off by the chip enable function so that the standby current can be minimized.

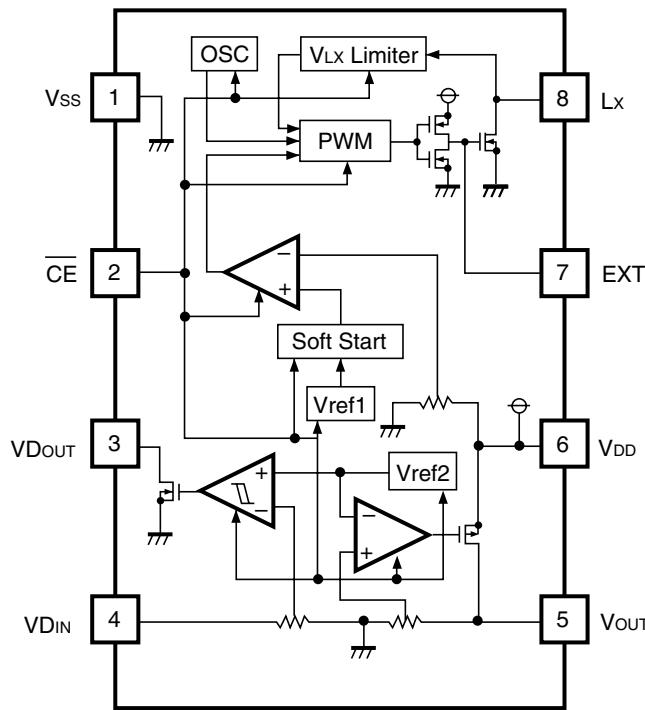
FEATURES

- Low Supply CurrentTyp. 55 μ A (RS5RM3624A : VIN=3.0V,at no load)
- Standby ModeIstandby=Max. 1.0 μ A (RS5RMxxxxA)
Istandby=Max. 10.0 μ A (RS5RMxxxxB)
- Low Voltage Operation PossibleOperating Voltage VIN=1.2V to 10V
- High Output Voltage AccuracyFixed Output Voltage Accuracy \pm 2.5%
- High Voltage Detection Accuracy \pm 2.5%
- Output Voltage can be set at User's request (refer to Selection Guide).
- Voltage close to battery's voltage can be output because these ICs are of a step-up / step-down type (Ex. a fixed voltage of 3V can be output by a 3V battery).
- Soft Start Function, built-in Protection Circuits for Lx Driver
- Phase Compensation Circuits built in
- Pin for External Driver is equipped, and a large current output can be obtained.
- Small Packages8pin SOP

APPLICATIONS

- Power source for cameras, camcorders, and hand-held audio equipment.
- Power source for small OA apparatus such as note book personal computers, and word processors.
- Power source for hand-held communication appliances such as pagers, cordless telephones, and cellular phones.

BLOCK DIAGRAM



SELECTION GUIDE

In the RS5RM Series, the output voltage, the detector threshold, the version symbols, and the taping type for the ICs can be selected at the user's request.

The selection can be made by designating the part number as shown below:

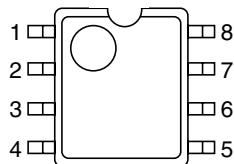
RS5RM_{xxxxx}-_{xx} ← Part Number
 ↑↑↑↑
 a b c d

Code	Contents
a	Setting Output Voltage (VOUT): Stepwise setting with a step of 0.1V in the range of 1.5V to 6.0V is possible.
b	Setting Detector Threshold (-VDET): Stepwise setting with a step of 0.1V in the range of 1.2V to 5.0V is possible.
c	Designation of Version Symbols: A: Operation of all the internal circuits is stopped by setting \overline{CE} pin at VDD level. B: Operation of only Step-up DC/DC converter is stopped by setting \overline{CE} pin at VDD level.
d	Designation of Taping Type: Ex. 8pin SOP : T1, T2 (refer to Taping Specification) “T2” is prescribed as a standard.

For example, the product with Output Voltage 5.0V, Detector Threshold 4.5V, Version A, and Taping Type T1, is designated by Part Number RS5RM5045A-T1.

PIN CONFIGURATION

- 8pin SOP



PIN DESCRIPTION

Pin No.	Symbol	Pin Description
1	Vss	Ground Pin
2	\overline{CE}	Chip Enable Pin
3	VDOUT	Voltage Detector Output Pin.Nch Open Drain Output
4	VDIN	Detection Input Pin of Voltage Detector
5	VOUT	Output Pin for Regulator
6	VDD	Step-up Output Pin.Power Supply Pin
7	EXT	External Transistor Drive Pin
8	Lx	External Inductor Drive Pin.

ABSOLUTE MAXIMUM RATINGS

Topt=25°C, Vss=0V

Symbol	Item		Rating	Unit
VDD	Supply Voltage		-0.3 to +12	V
VLX	Output Voltage	Lx Pin Voltage		V
VEXT		EXT Pin Voltage		V
VOUT		VOUT Pin Voltage		V
VDOUT		VDOUT Pin Voltage		V
VCE	Input Voltage	CE Pin Voltage		V
VDIN		VDIN Pin Voltage	A Version	V
			B Version	V
ILX	Inductor Drive Output Current	Lx Pin Current	250	mA
IEXT		EXT Pin Current	50	mA
Pd	Power Dissipation		300	mW
Topt	Operating Temperature Range		-30 to +80	°C
Tstg	Storage Temperature Range		-55 to +125	°C
Tsolder	Lead Temperature (Soldering)		260°C, 10s	

ABSOLUTE MAXIMUM RATINGS

Absolute Maximum ratings are threshold limit values that must not be exceeded even for an instant under any conditions. Moreover, such values for any two items must not be reached simultaneously. Operation above these absolute maximum ratings may cause degradation or permanent damage to the device. These are stress ratings only and do not necessarily imply functional operation below these limits.

ELECTRICAL CHARACTERISTICS

• RS5RM3624A,B

Topt=25°C

Symbol	Item	Conditions	Min.	Typ.	Max.	Unit	Note
VIN	Operation Input Voltage	No load	1.2		10	V	
VDD	Step-up Output Voltage	No load	3.99	4.10	4.21	V	
Voscst	Oscillator Start-up Voltage	No load		0.9	1.2	V	
Vhold	Hold-on Voltage	IOUT=1mA	0.7			V	
fosc	Oscillator Frequency		40	50	60	kHz	
Maxdty	Oscillator Maximum Duty Cycle		65	80	90	%	
VOL1	Lx Output Voltage	IOL=50mA			0.5	V	
IOH1	Lx Leakage Current			0.01	10.00	µA	
VLXlim	Lx Voltage Limit	Lx Pin On		0.9		V	
VOH	EXT Output Pch ON Voltage	IEXT=-3mA, VDD=4.1V	3.6			V	
VOL2	EXT Output Nch ON Voltage	IEXT=5mA, VDD=4.1V			0.5	V	
VOUT	Output Voltage	IRL=-5mA	3.51	3.60	3.69	V	
VDIF	Dropout Voltage	IRL=-30mA		0.3		V	
ΔVOUT/ΔIOUT	Load Regulation	-30mA≤IRL≤0mA			100	mV	
-VDET	Detector Threshold		2.34	2.40	2.46	V	
VHYS	Detector Threshold Hysteresis		60	120	240	mV	
VOL3	VDOUT ON Voltage	IOL=5mA			0.5	V	
IOH2	VDOUT Leakage Current			0.01	5.00	µA	
IVDINH	VDIN "H" Input Current	VDIN=VDD			5	µA	
IVDINL	VDIN "L" Input Current	VDIN=Vss	-0.5		0.5	µA	
VCEH	CE "H" Input Voltage		VDD-0.3		VDD	V	
VCEL	CE "L" Input Voltage		0		0.2VDD	V	
ICEH	CE "H" Input Current	CE=VDD	-0.5		0.5	µA	
ICEL	CE "L" Input Current	CE=Vss	-0.5		0.5	µA	
IDD	Supply Current	VIN=3V, L=100µH, C=22µF, CE=Vss, No load		55	120	µA	
Istandby	Standby Current	VIN=3V, L=100µH, C=22µF, CE=VDD, No load			1.0	µA	Note1
					10.0	µA	Note2

(Note 1) Standby current of Version A

(Note 2) Standby current of Version B

Please refer to Basic Circuit for Test Circuit.

• RS5RM5045A,B

Topt=25°C

Symbol	Item	Conditions	Min.	Typ.	Max.	Unit	Note
VIN	Operation Input Voltage	No load	1.2		10	V	
VDD	Step-up Output Voltage	No load	5.36	5.50	5.64	V	
Voscst	Oscillator Start-up Voltage	No load		0.9	1.2	V	
Vhold	Hold-on Voltage	IOUT=1mA	0.7			V	
fosc	Oscillator Frequency		40	50	60	kHz	
Maxdty	Oscillator Maximum Duty Cycle		65	80	90	%	
VOL1	Lx Output Voltage	IOL=50mA			0.5	V	
IOH1	Lx Leakage Current			0.01	10.00	µA	
VLXlim	Lx Voltage Limit	Lx Pin On		0.9		V	
VOH	EXT Output Pch ON Voltage	IEXT=-3mA, VDD=5.5V	5.0			V	
VOL2	EXT Output Nch ON Voltage	IEXT=5mA, VDD=5.5V			0.5	V	
VOUT	Output Voltage	IRL=-5mA	4.87	5.00	5.13	V	
VDIF	Dropout Voltage	IRL=-30mA		0.3		V	
ΔVOUT/ΔIOUT	Load Regulation	-30mA≤IRL≤0mA			100	mV	
-VDET	Detector Threshold		4.38	4.50	4.62	V	
VHYS	Detector Threshold Hysteresis		112	225	450	mV	
VOL3	VDOUT ON Voltage	IOL=5mA			0.5	V	
IOH2	VDOUT Leakage Current			0.01	5.00	µA	
IVDINH	VDIN "H" Input Current	VDIN=VDD			5	µA	
IVDINL	VDIN "L" Input Current	VDIN=Vss	-0.5		0.5	µA	
VCEH	CE "H" Input Voltage		VDD-0.3		VDD	V	
VCEL	CE "L" Input Voltage		0		0.2VDD	V	
ICEH	CE "H" Input Current	CE=VDD	-0.5		0.5	µA	
ICEL	CE "L" Input Current	CE=Vss	-0.5		0.5	µA	
IDD	Supply Current	VIN=4V, L=100µH, C=22µF, CE=Vss, No load		70	150	µA	
Istandby	Standby Current	VIN=4V, L=100µH, C=22µF, CE=VDD, No load		1.0	µA	Note1	
					10.0	µA	Note2

(Note 1) Standby current of Version A

(Note 2) Standby current of Version B

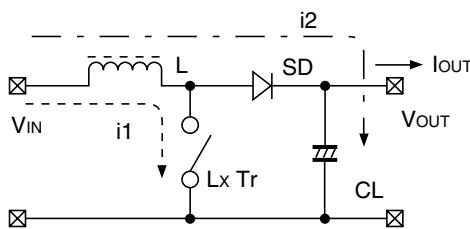
Please refer to Basic Circuit for Test Circuit.

OPERATION OF STEP-UP DC/DC CONVERTER

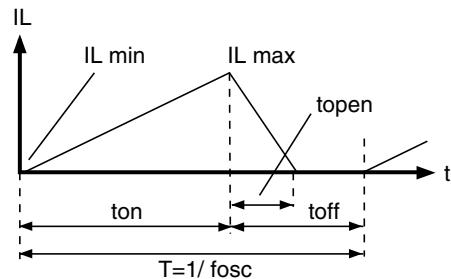
Step-up DC/DC Converter charges energy in the inductor when Lx Transistor (LxTr) is ON, and discharges the energy with the addition of the energy from Input Power Source thereto when LxTr is OFF, so that a higher output voltage than the input voltage is obtained.

The operation will be explained with reference to the following diagrams :

< Basic Circuits >



< Current through L >



Step.1: LxTr is turned ON and current $IL (=i_1)$ flows, so that energy is charged in L. At this moment, $IL (=i_1)$ is increased from $IL_{min} (=0)$ to reach IL_{max} in proportion to the on-time period (t_{on}) of LxTr.

Step.2: When LxTr is turned OFF, Schottky diode (SD) is turned ON in order that L maintains IL at IL_{max} , so that current $IL (=i_2)$ is released.

Step.3: $IL (=i_2)$ is gradually decreased, and in the case of discontinuous mode, IL reaches $IL_{min} (=0)$ after a time period of t_{open} , so that SD is turned OFF. In the case of a continuous mode, the time period (t_{off}) runs out before IL reaches $IL_{min} (=0)$, so that LxTr is turned ON in the next cycle, and SD is turned OFF. In this case, IL_{min} does not reach zero, and $IL (=i_1)$ increases from $IL_{min} (>0)$.

In the case of PWM control system, with the oscillator frequency (f_{osc}) maintained constant, the output voltage is maintained constant by controlling the on-time period (t_{on}).

OPERATION

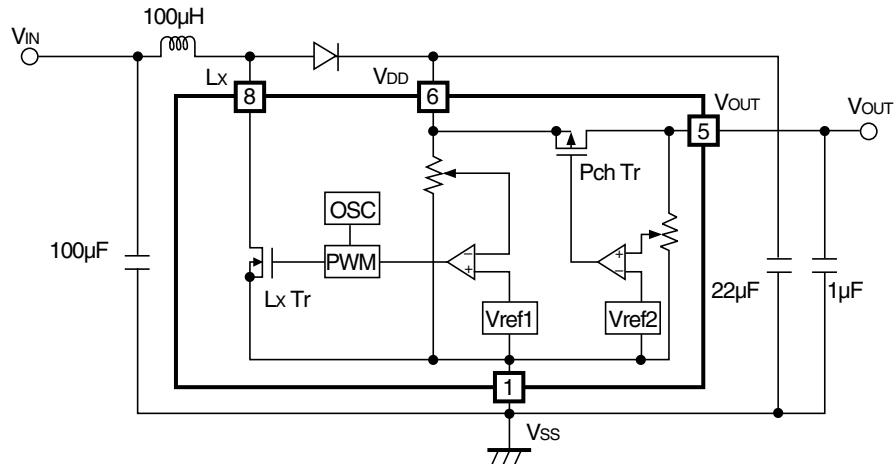


FIG. A Diagram of RS5RM including external circuits

1. VDD Output Voltage

VDD output voltage is shown in Fig. B.

- (1) In the case of $V_{IN} - V_f \geq V_{DD0}$:

In Area B, LxTr is maintained in an OFF state, so that $V_{IN} - V_f$ (V) is output as it is from VDD pin without step-up operation.

- (2) In the case of $V_{IN} - V_f < V_{DD0}$:

In Area A, this IC functions as Step-up DC/DC converter. The step-up operation will now be explained with reference to FIG. A. The step-up operation is an operation for regulating the VDD output voltage by comparing Vref1 and the VDD output voltage by error amplifier circuits and subjecting LxTr to on-time control by PWM circuits (i.e., by controlling the step-up operation).

2. VOUT Output Voltage

A constant voltage is output from VOUT pin, with above-mentioned the VDD output voltage being subjected to a step-down operation by a linear regulator. This step-down operation will now be explained with reference to FIG. A. The step-down operation is an operation for regulating the VDD output voltage by Pch Tr by comparing Vref2 and the VDD output voltage.

V_{IN}	: Input Voltage
V_{DD0}	: VDD Set Voltage
V_{OUT0}	: VOUT Set Voltage
V_f	: ON Voltage of Diode

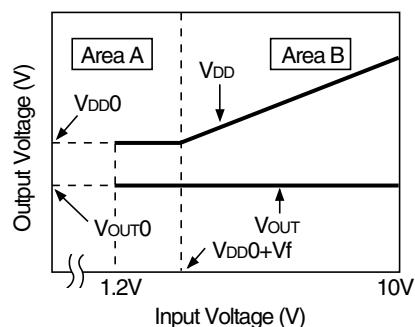
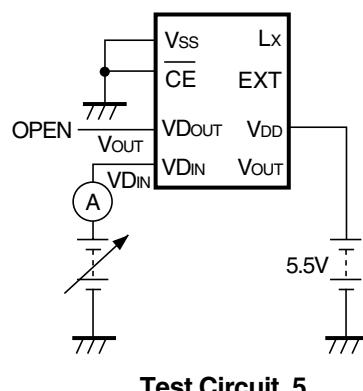
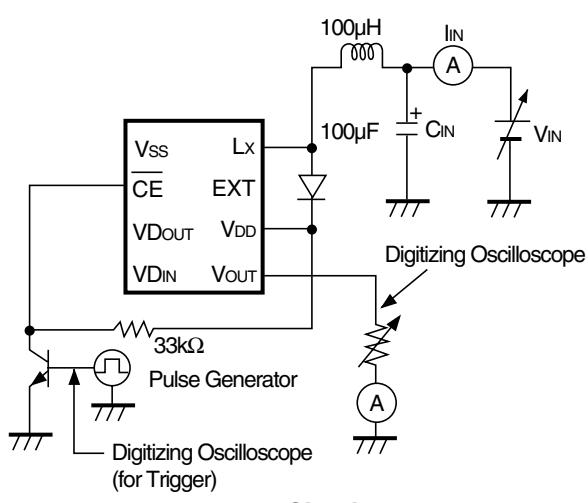
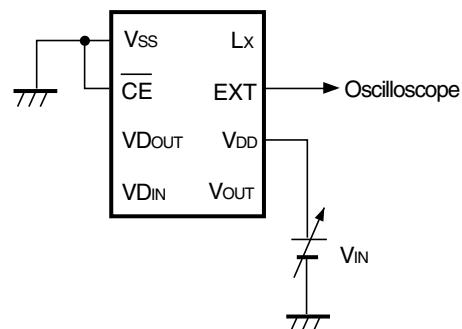
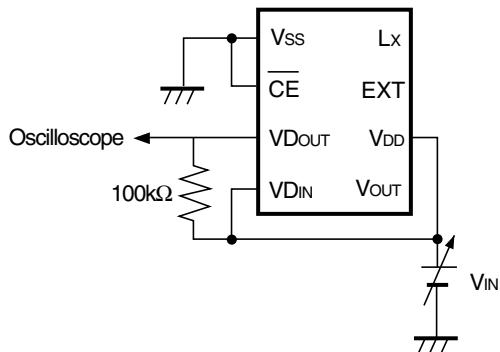
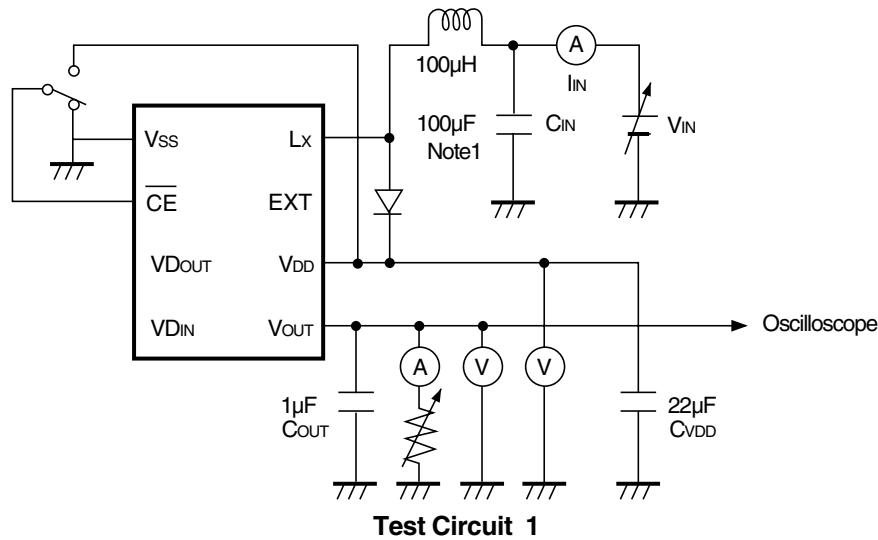
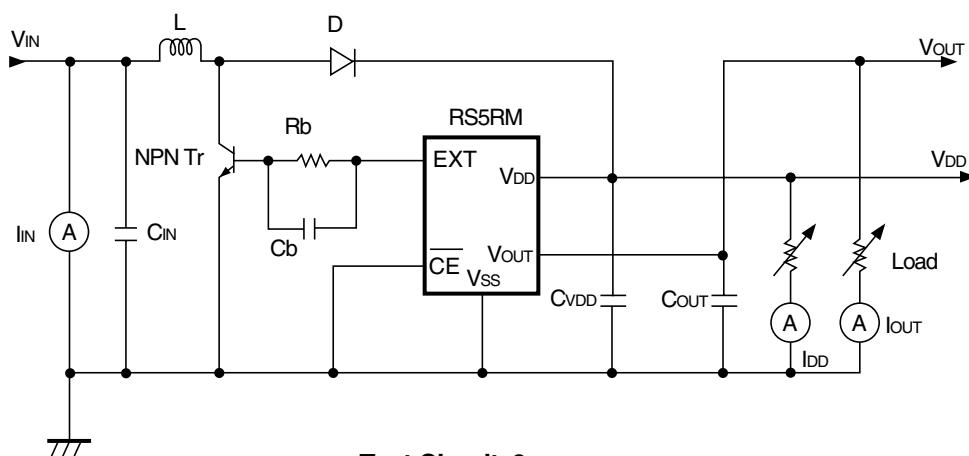
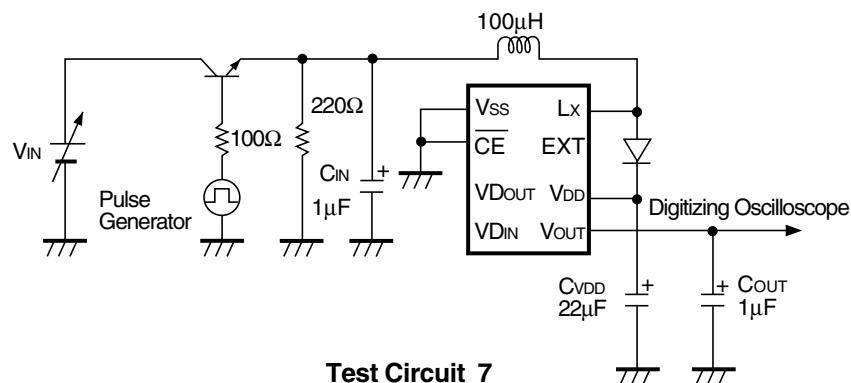
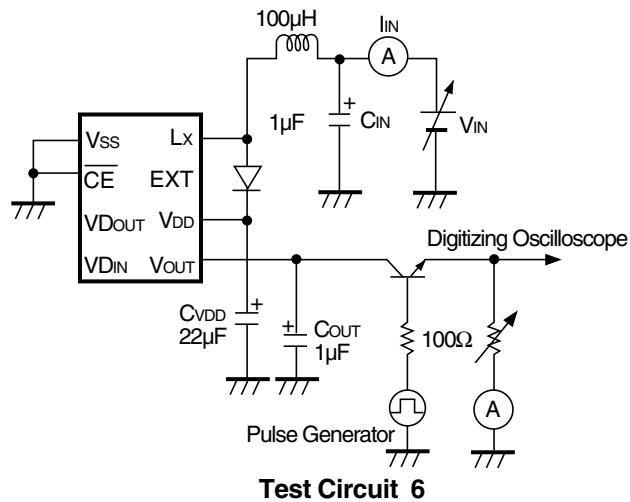


FIG. B Output Voltage vs. Input Voltage characteristic

TEST CIRCUITS





L : 47μH(SUMIDA ELECTRIC CD105)
D : Schottky Diode (HITACHI HRP22)
C_{IN} : 220μF(Aluminum electrolytic Type)
R_b : 220Ω

C_b : 0.01μF
C_{VDD} : 220μF(Aluminum electrolytic Type)
C_{OUT} : 1μF(Tantalum Type)

By use of these test circuits, the typical characteristics were obtained as shown in the following pages:

Test Circuit 1: Typical Characteristics 1) 2) 3) 4) 5) 9) 10) 13) 14) 16)

(Typical Characteristics 13) and 14) were measured by replacing the capacitor shown in Note1 with a 1 μ F Capacitor)

Test Circuit 2: Typical Characteristics 11) 12)

Test Circuit 3: Typical Characteristics 7) 8)

Efficiency η is shown by the following formula:

$$\eta = (V_{OUT} \times I_{OUT}) / (V_{IN} \times I_{IN})$$

Test Circuit 4: Typical Characteristics 6)

Test Circuit 5: Typical Characteristics 15)

Test Circuit 6: Typical Characteristics 17)

Test Circuit 7: Typical Characteristics 18)

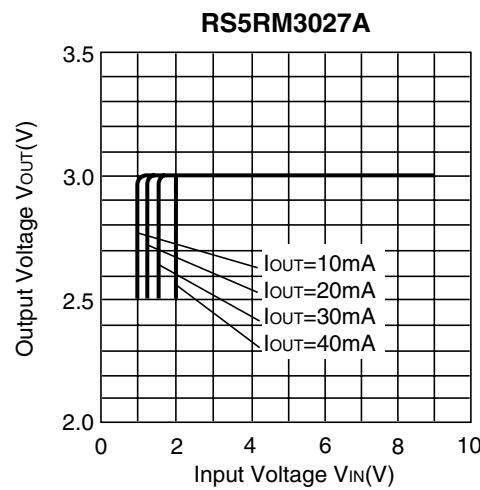
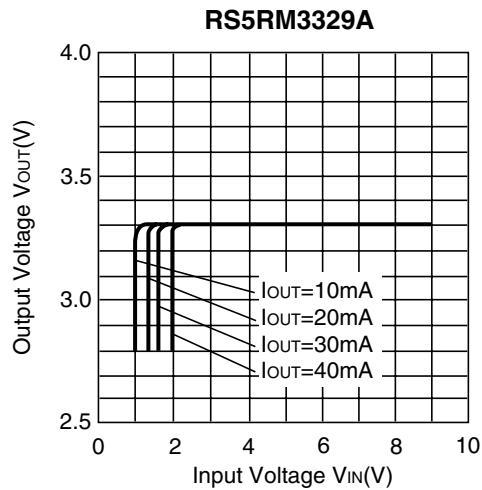
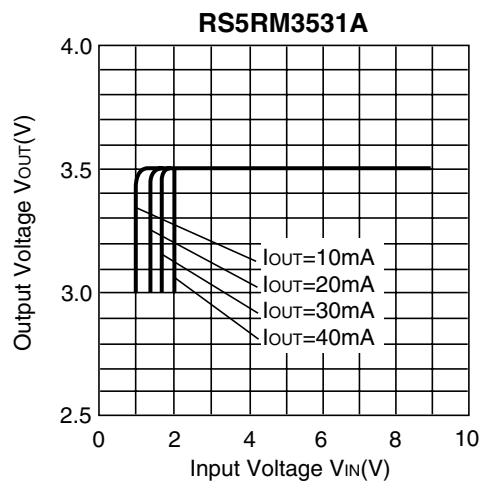
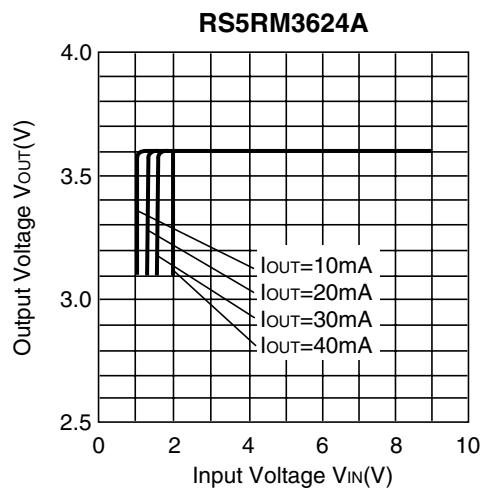
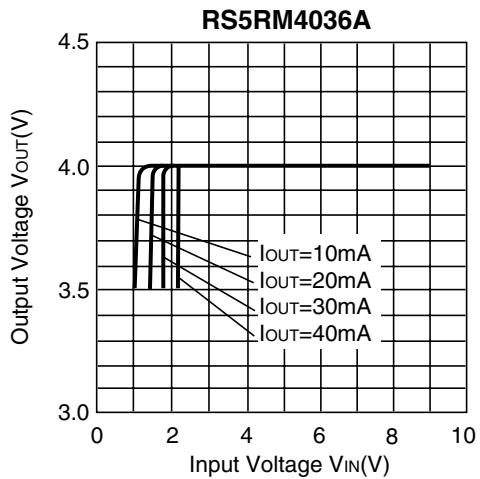
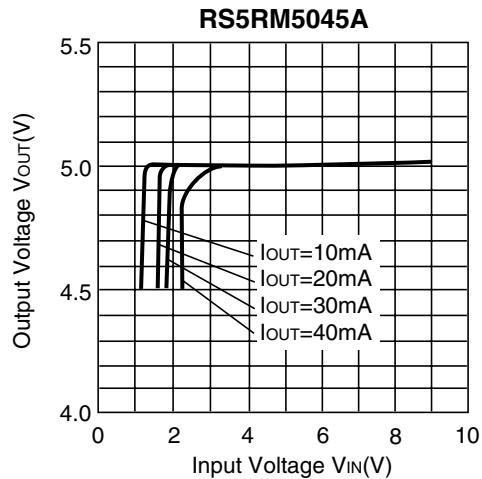
Test Circuit 8: Typical Characteristics 19) 20)

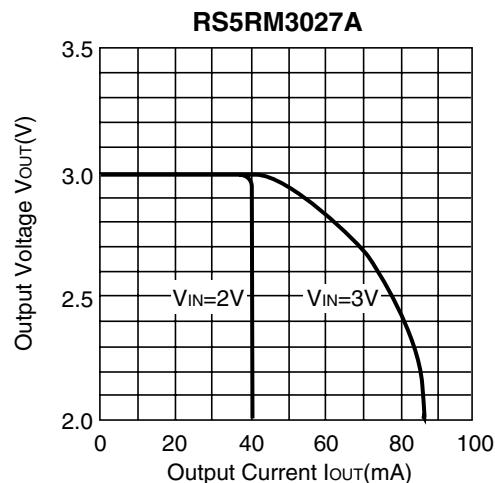
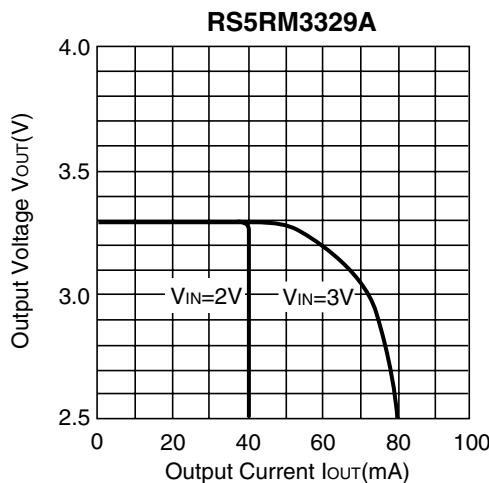
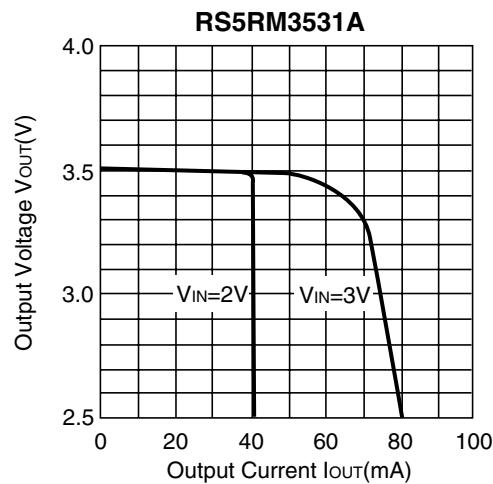
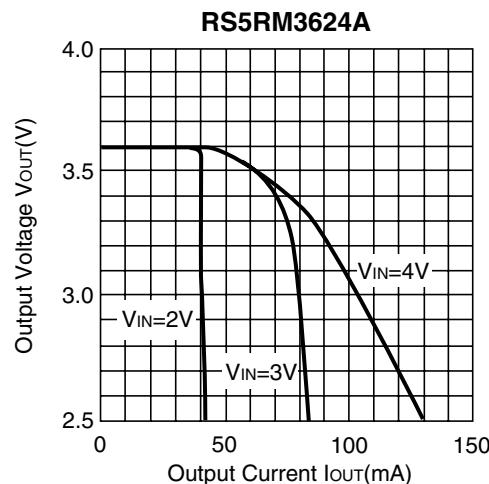
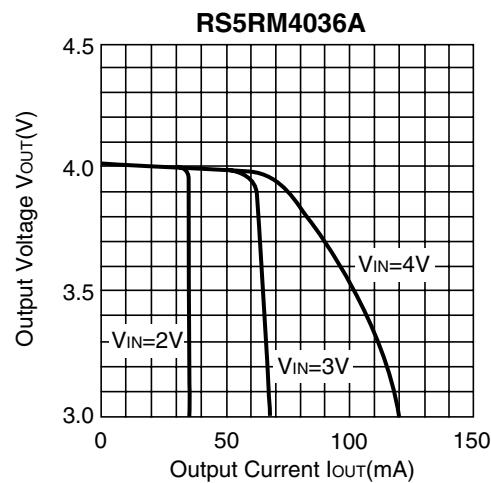
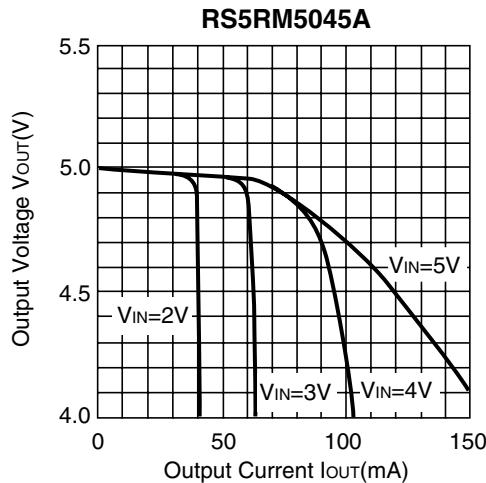
In the present IC, input current at no load is defined as supply current. ($\overline{CE} = V_{SS}$).

And when $\overline{CE} = V_{DD}$, the input current (no load) is defined as standby current.

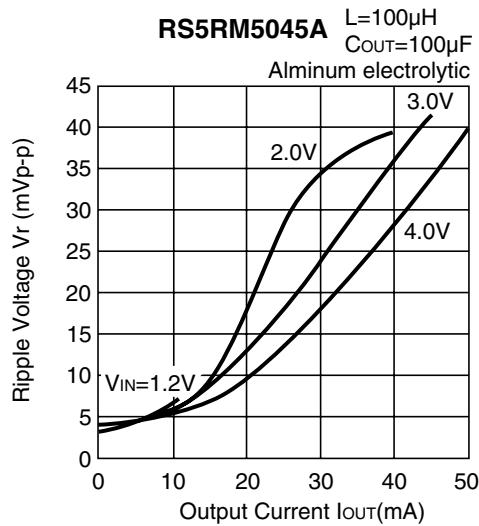
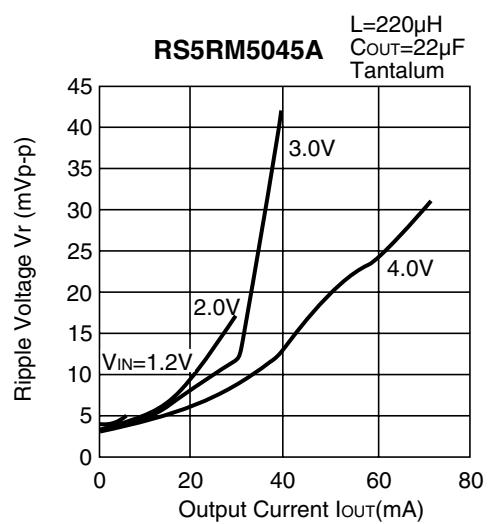
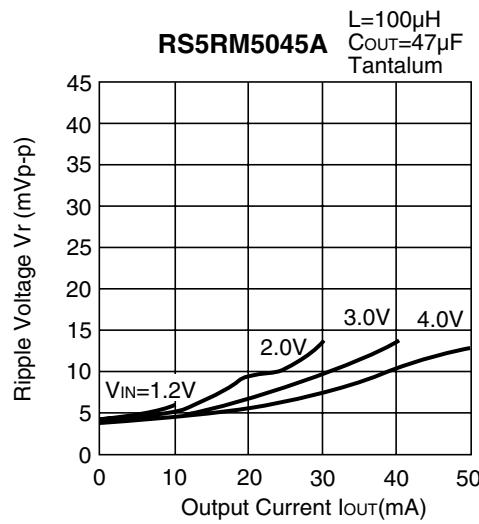
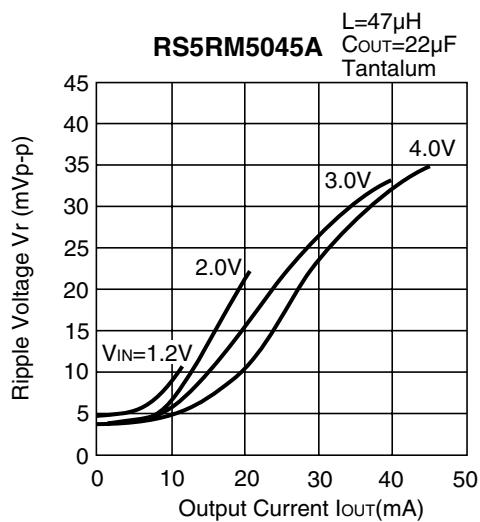
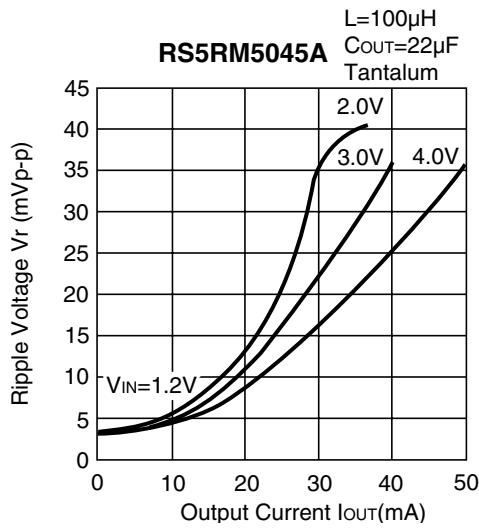
TYPICAL CHARACTERISTICS

1) Output Voltage vs. Input Voltage ($T_{opt}=25^{\circ}\text{C}$)



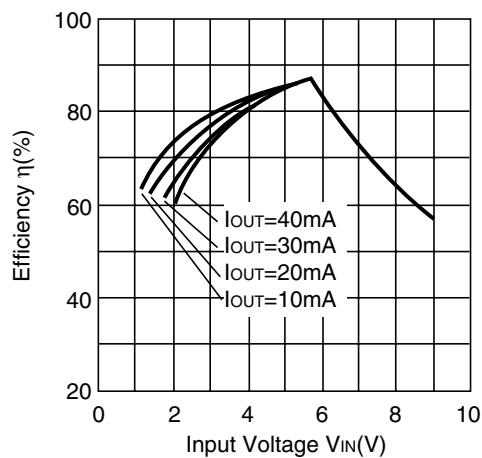
2) Output Voltage vs. Output Current ($T_{opt}=25^{\circ}\text{C}$)

3) Ripple Voltage vs. Output Current (Topt=25°C)

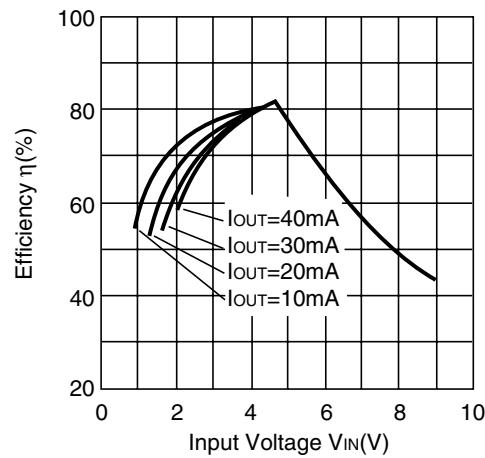


4) Efficiency vs. Input Voltage ($T_{opt}=25^{\circ}\text{C}$)

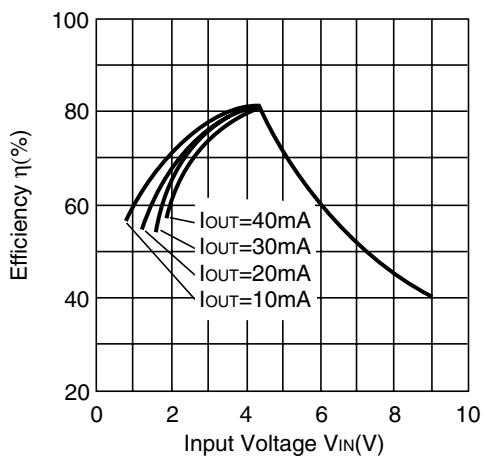
RS5RM5045A



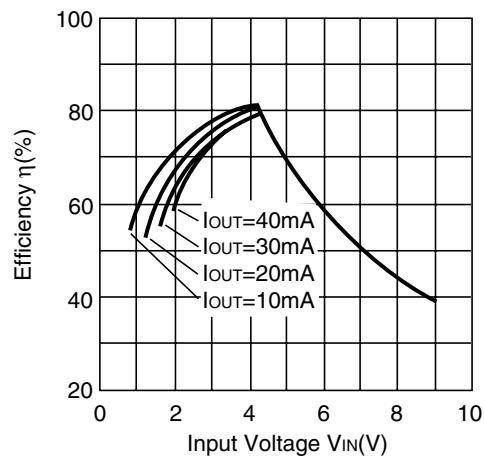
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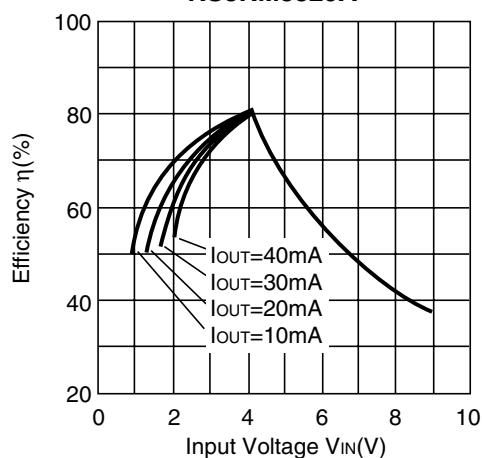
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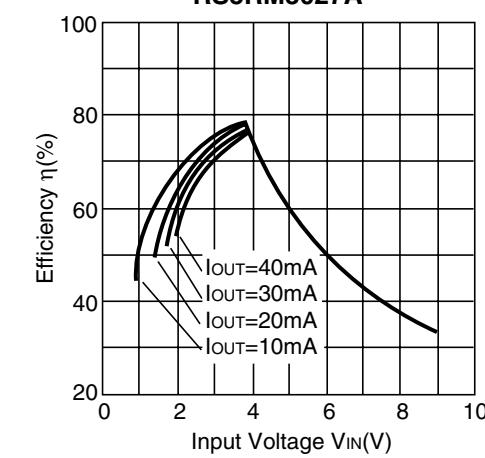
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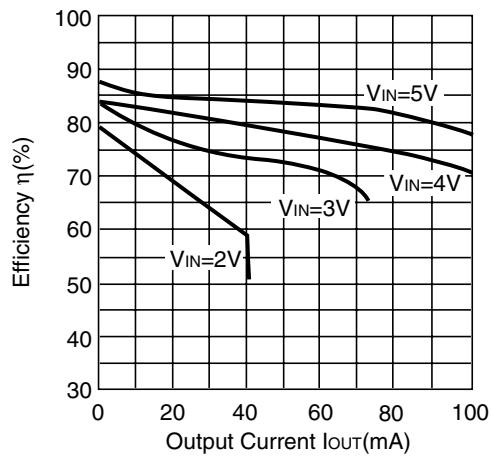
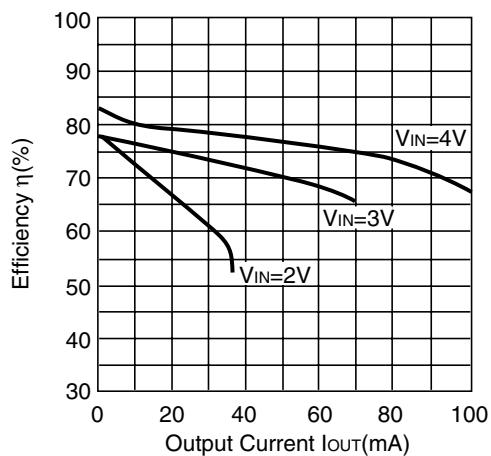
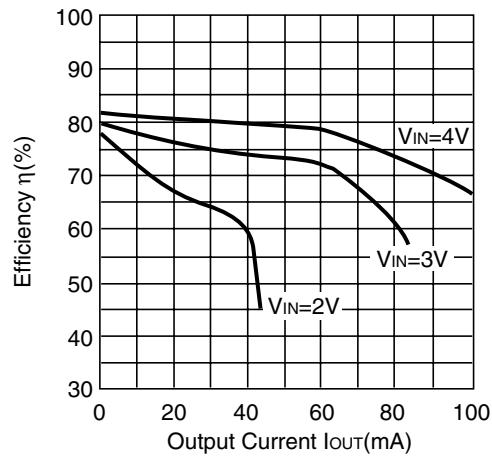
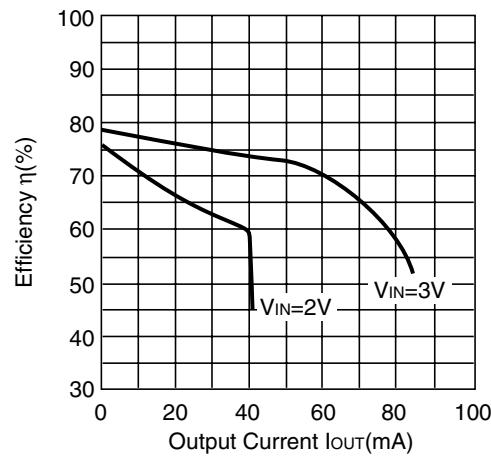
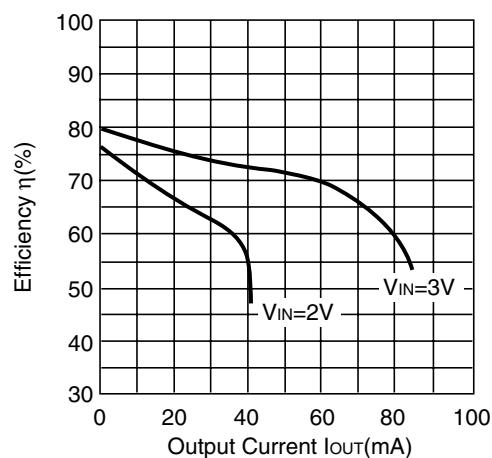
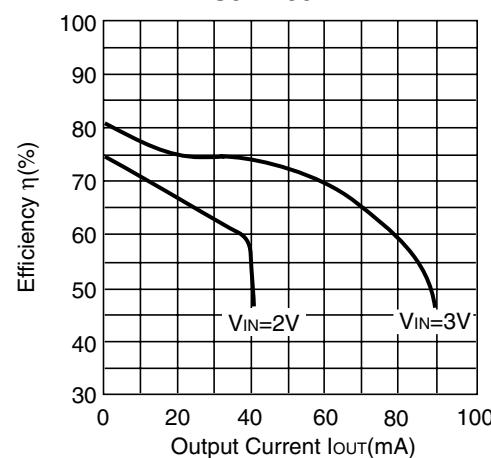


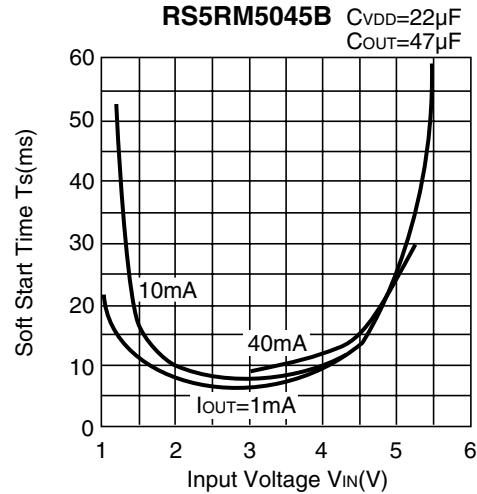
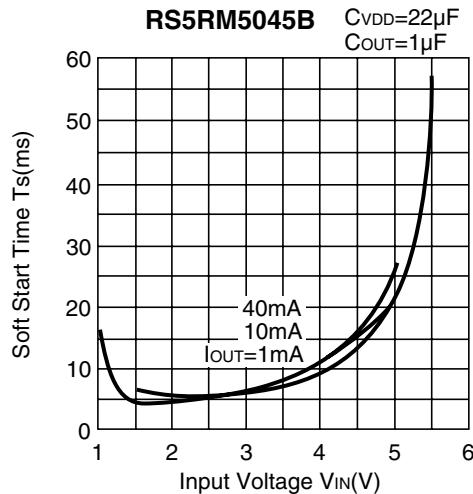
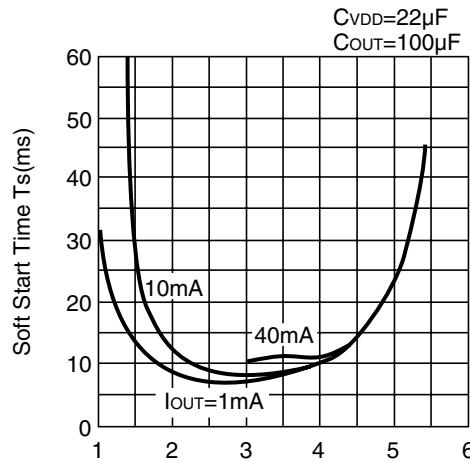
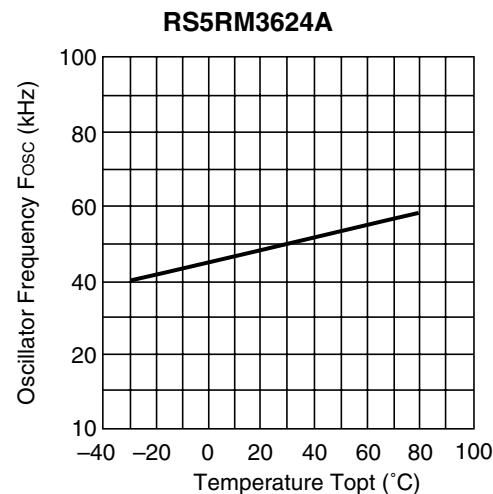
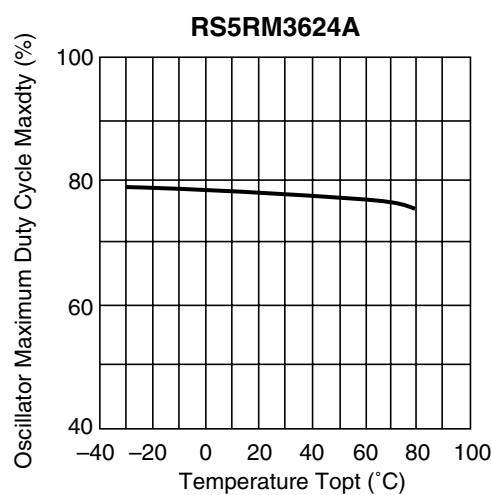
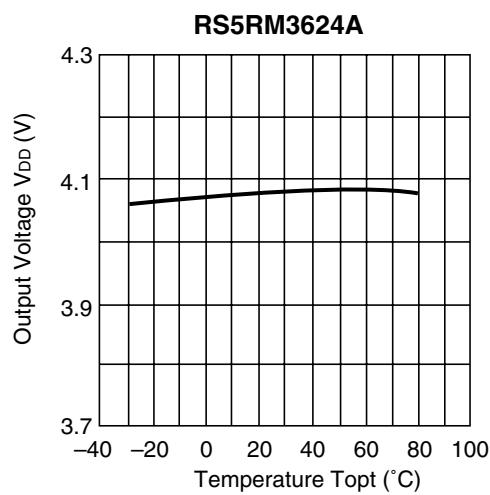
RS5RM3329A

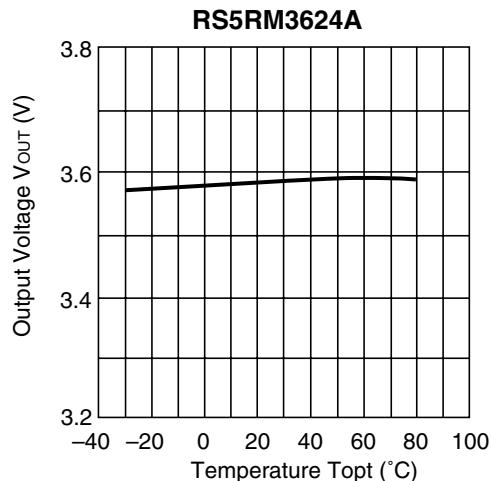
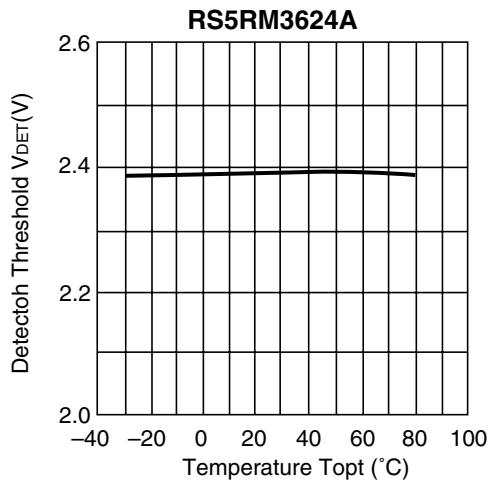
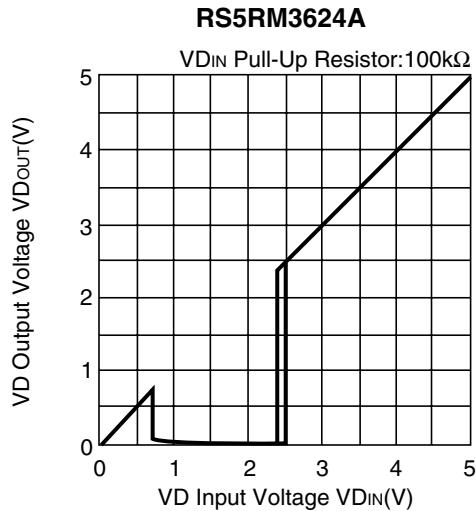
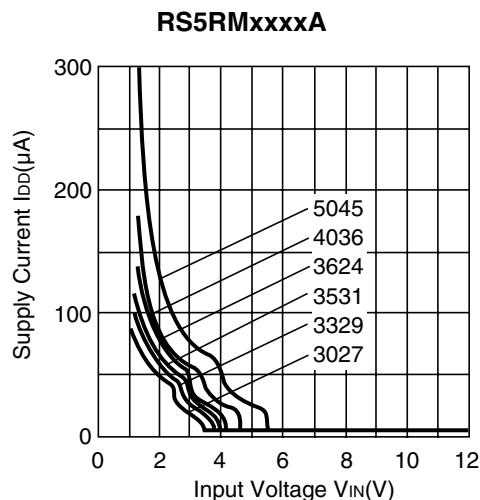
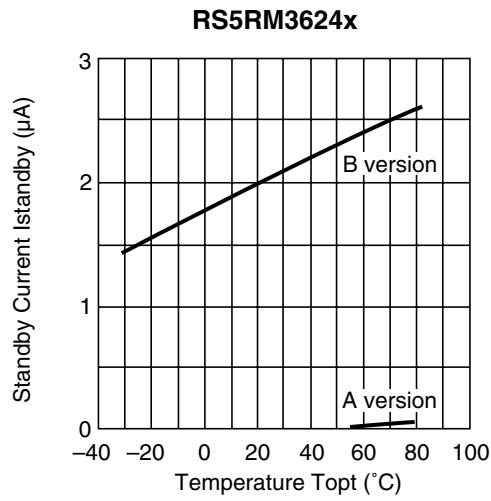
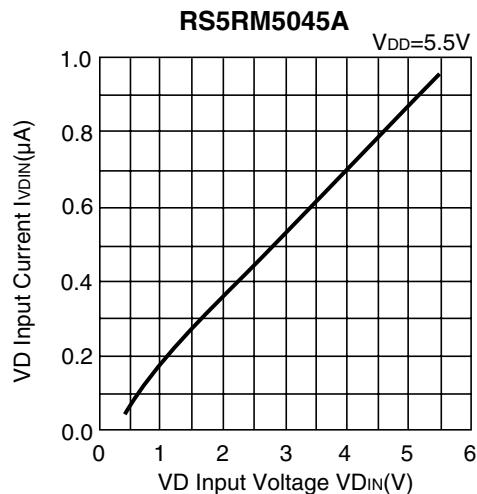


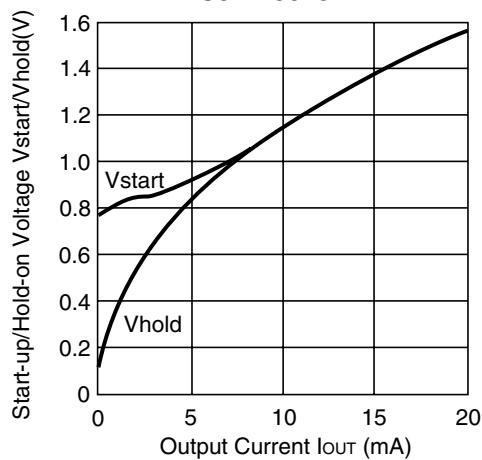
RS5RM3027A

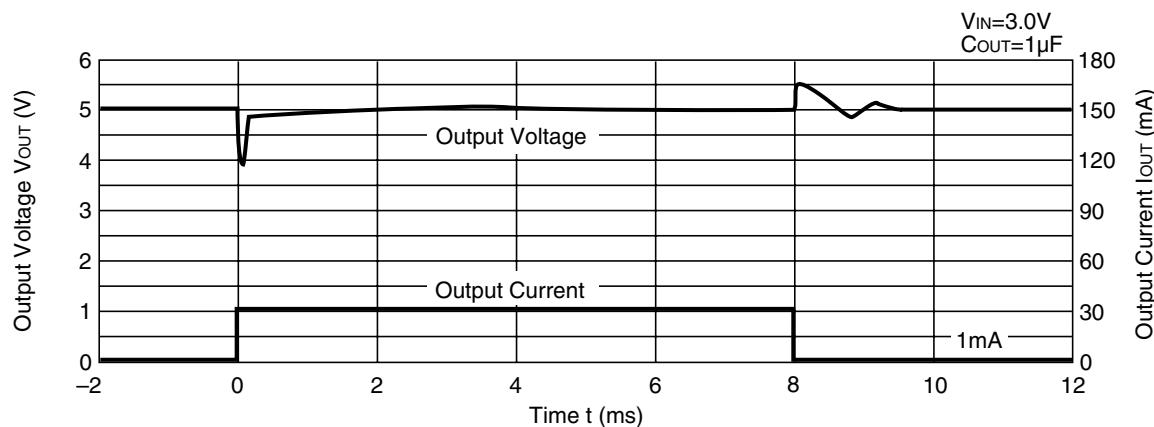
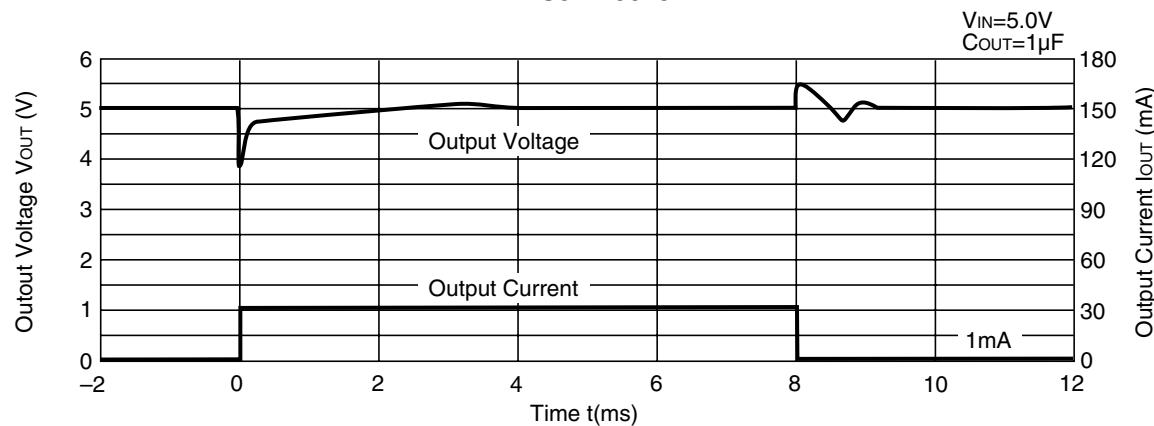
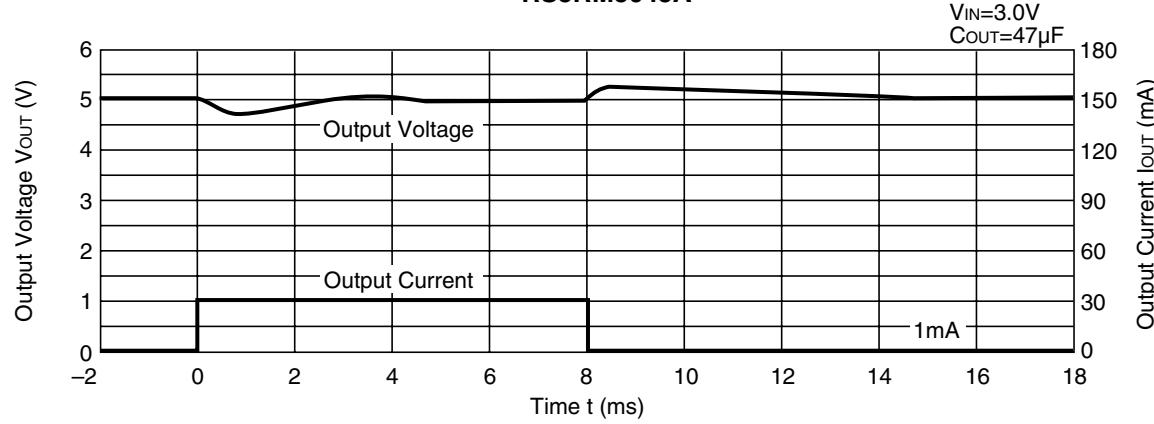


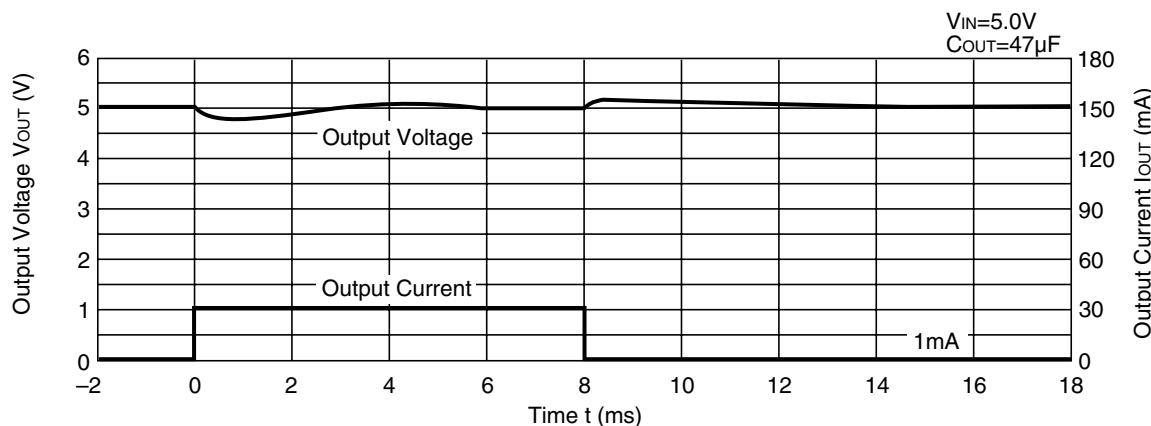
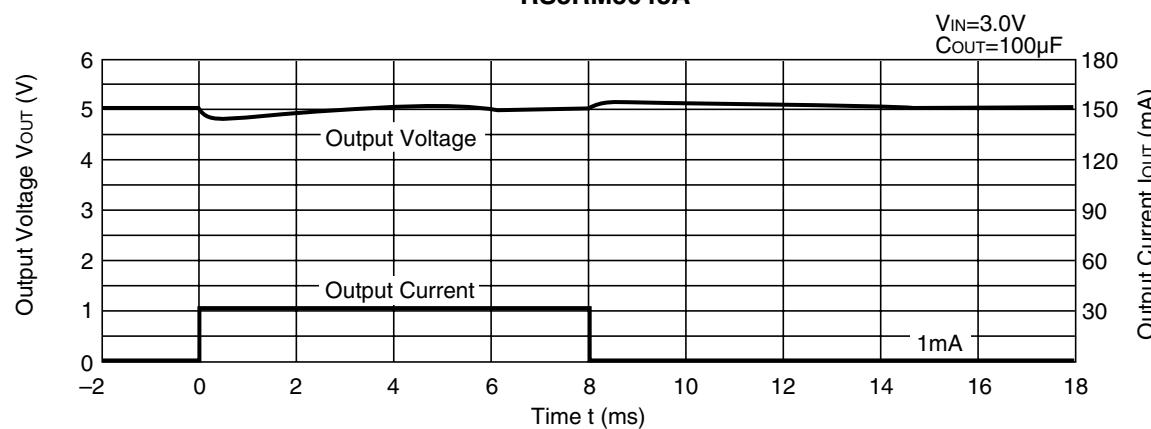
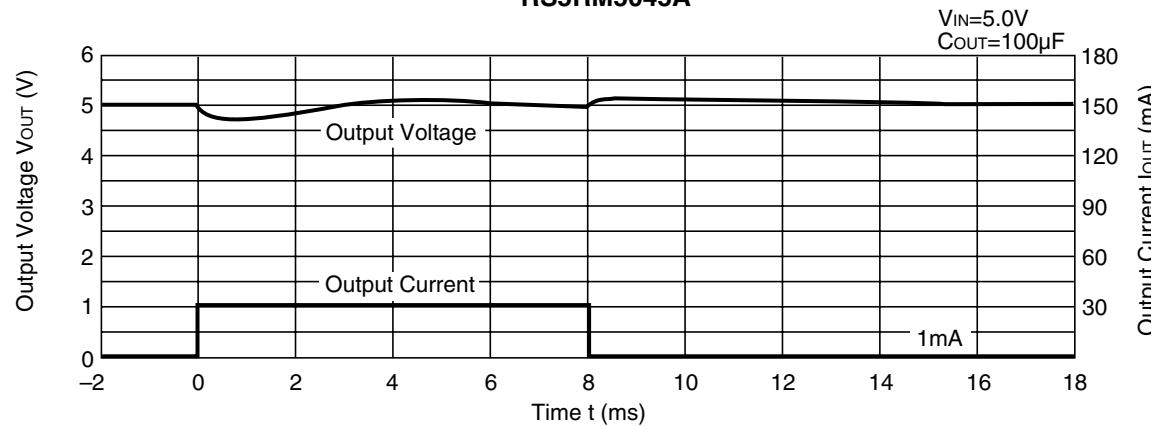
5) Efficiency vs. Output Current ($T_{opt}=25^{\circ}\text{C}$)**RS5RM5045A****RS5RM4036A****RS5RM3624A****RS5RM3531A****RS5RM3329A****RS5RM3027A**

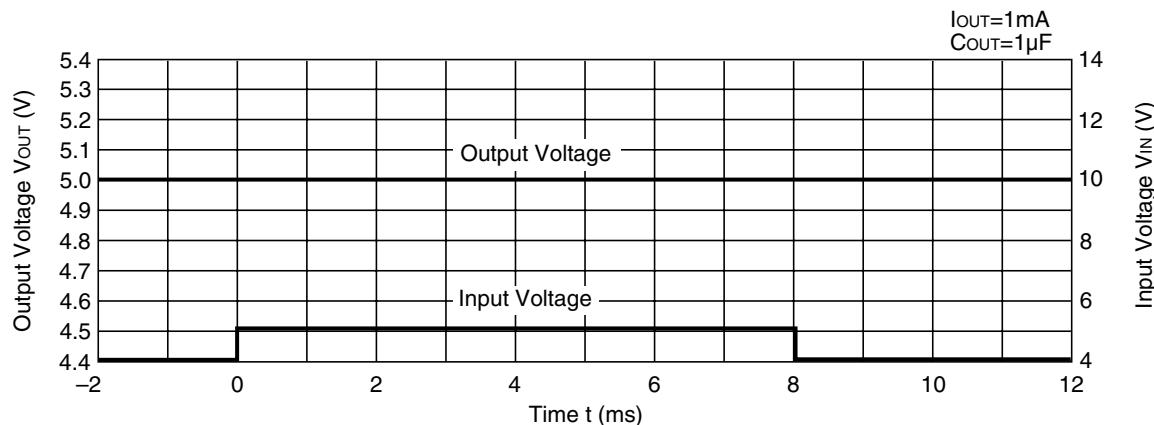
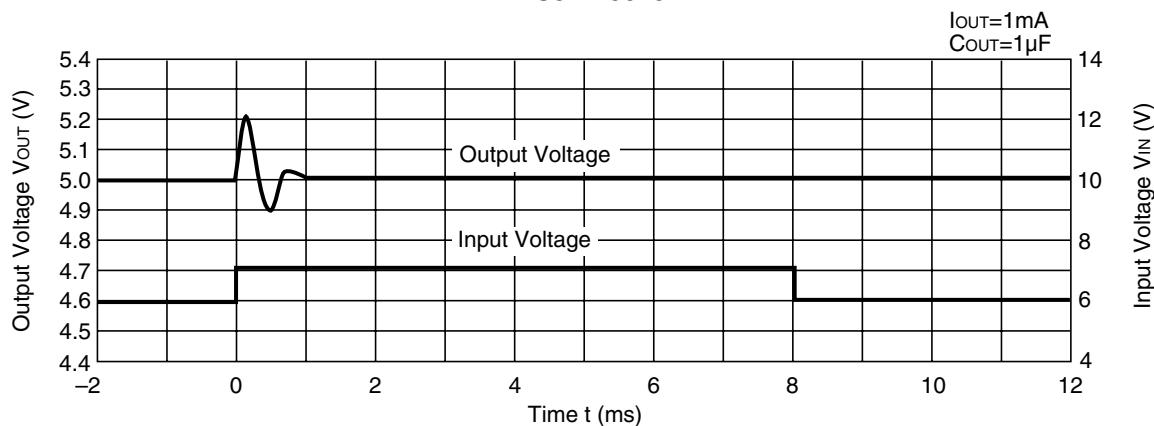
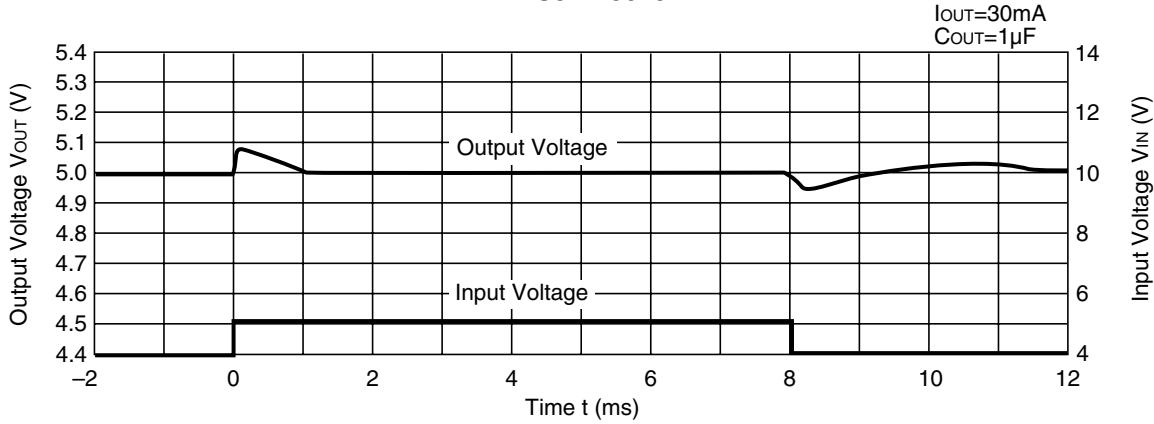
6) Soft Start Time vs. Input Voltage ($T_{opt}=25^{\circ}\text{C}$)**RS5RM5045B****7) Oscillator Frequency vs. Temperature****8) Oscillator Maximum Duty Cycle vs. Temperature****9) Output Voltage (V_{DD}) vs. Temperature**

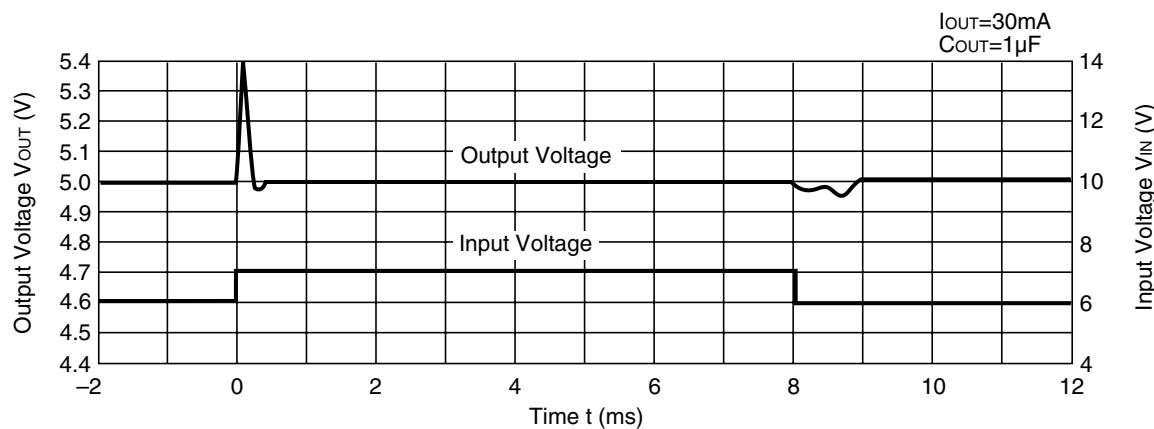
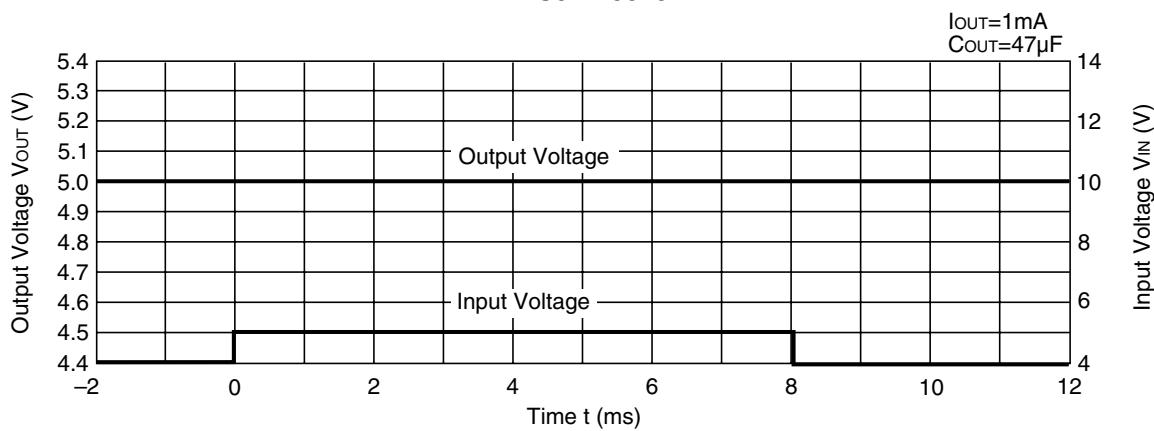
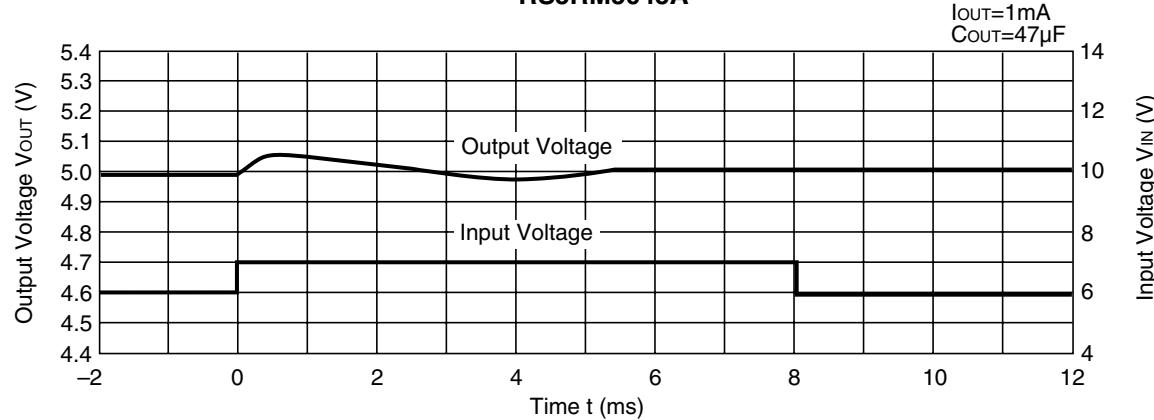
10) Output Voltage vs. Temperature**11) Detector Threshold vs. Temperature****12) VD Output Voltage vs. VD Input Voltage****13) Supply Current vs. Input Voltage****14) Standby Current vs. Temperature****15) VD Input Current vs. VD Input Voltage**

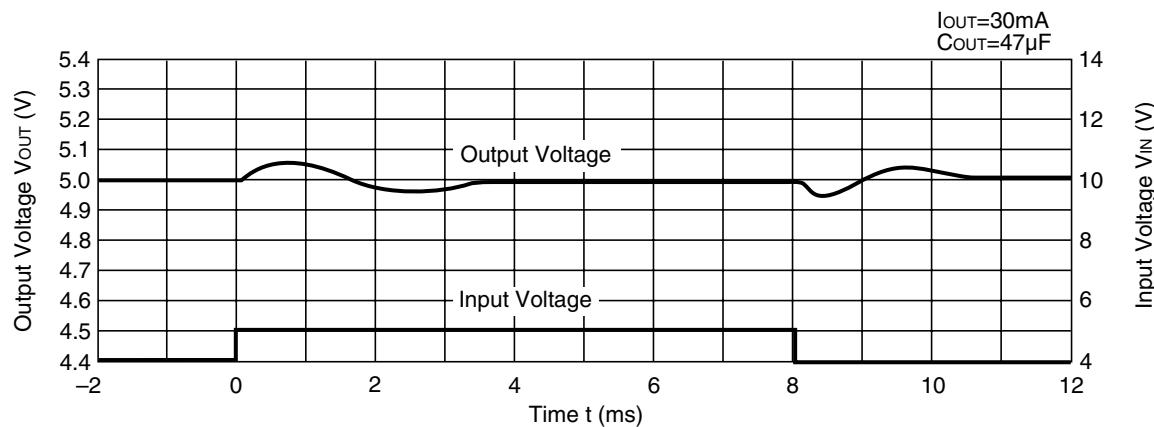
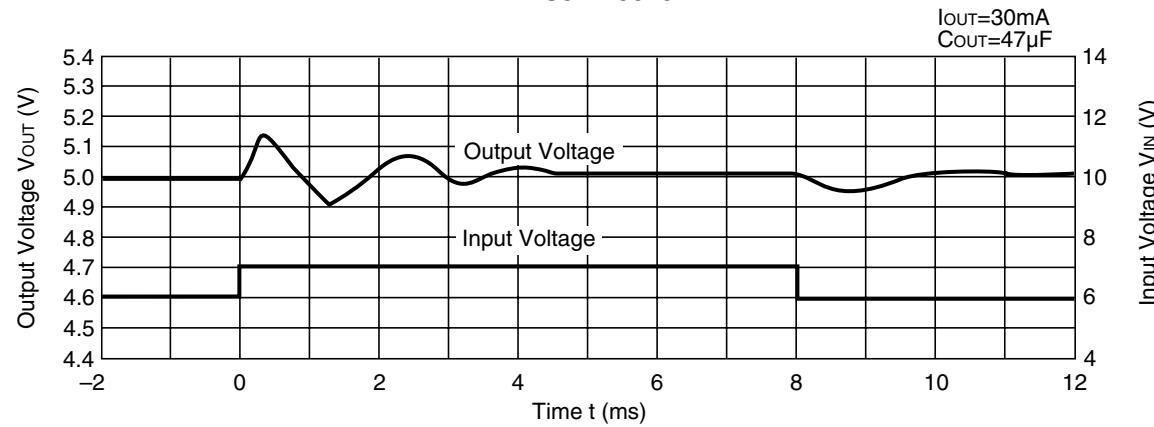
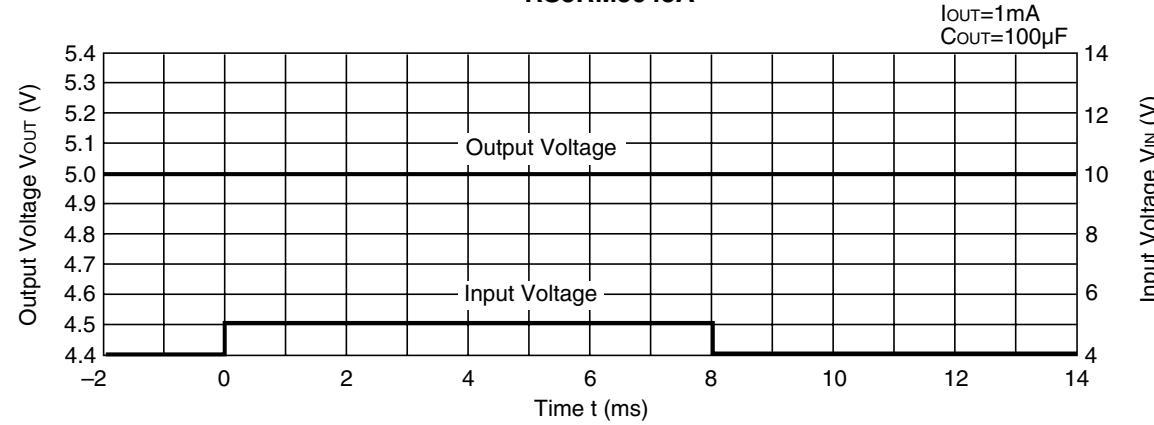
16) Start-up/Hold-on Voltage vs. Output Current**RS5RM5045A**

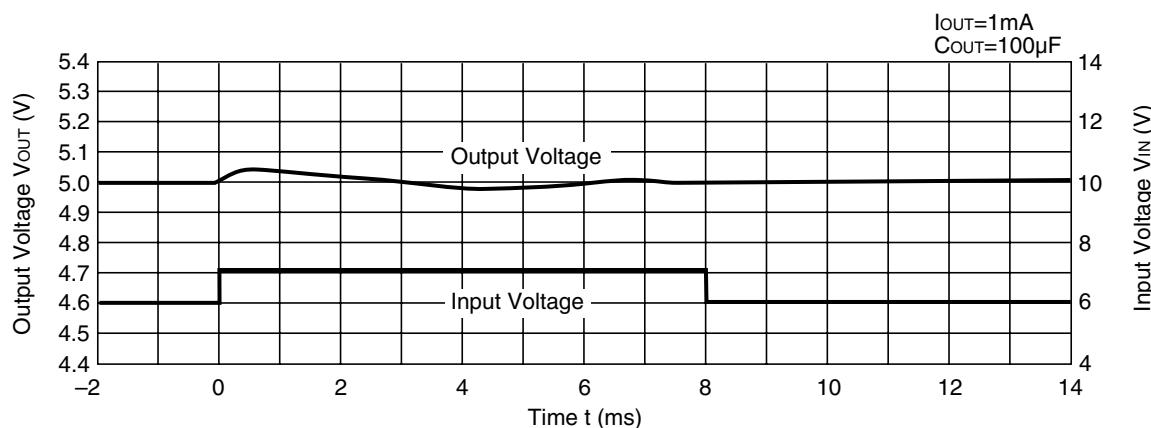
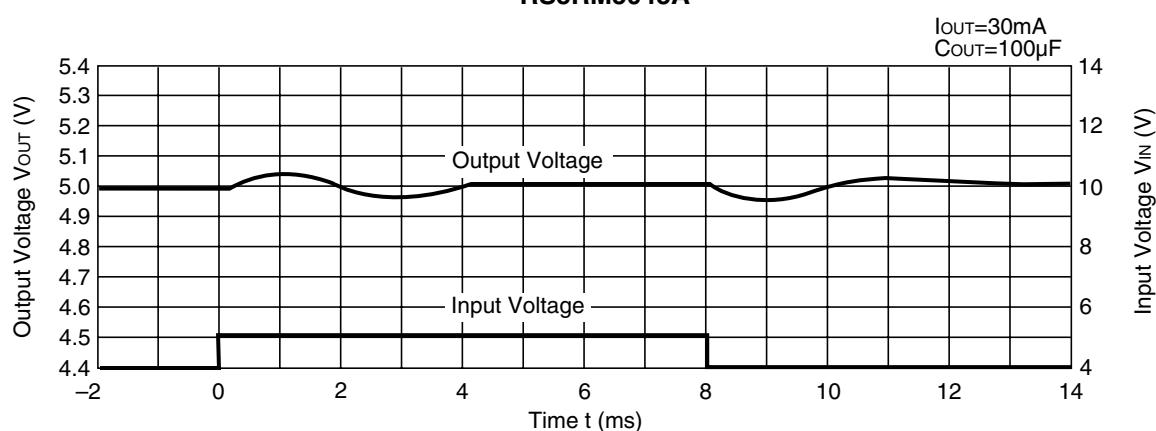
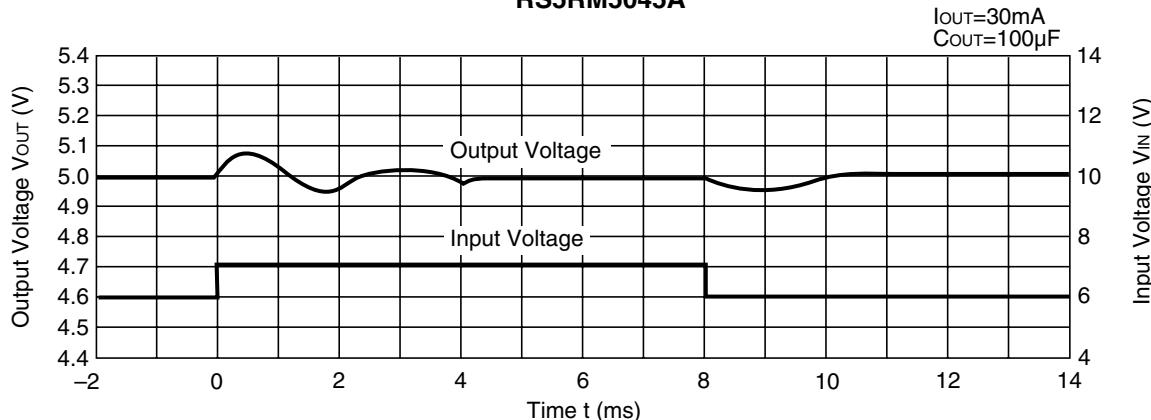
17) Load Transient Response**RS5RM5045A****RS5RM5045A****RS5RM5045A**

RS5RM5045A**RS5RM5045A****RS5RM5045A**

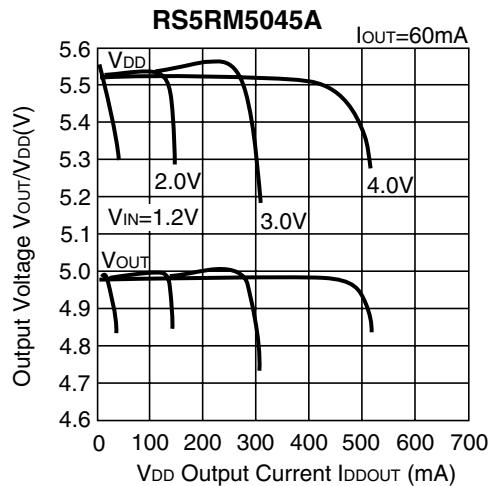
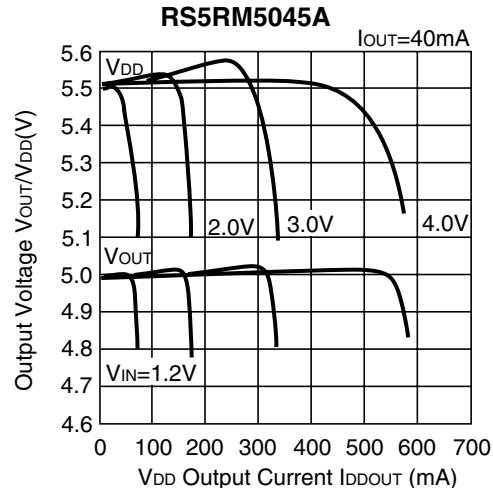
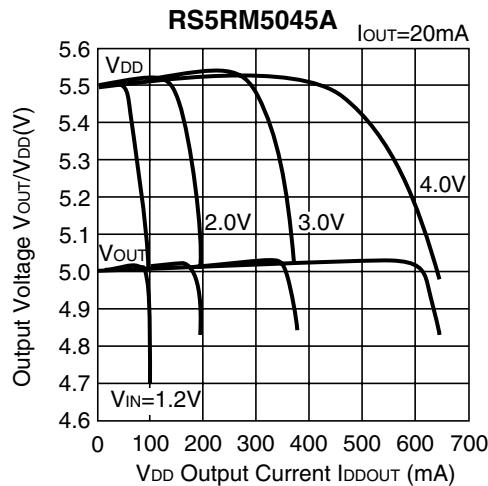
18) Line Transient Response**RS5RM5045A****RS5RM5045A****RS5RM5045A**

RS5RM5045A**RS5RM5045A****RS5RM5045A**

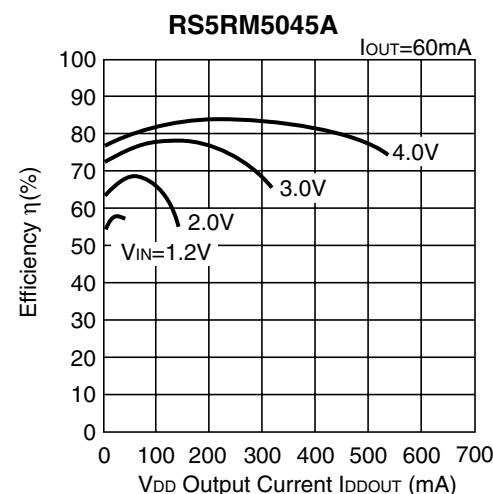
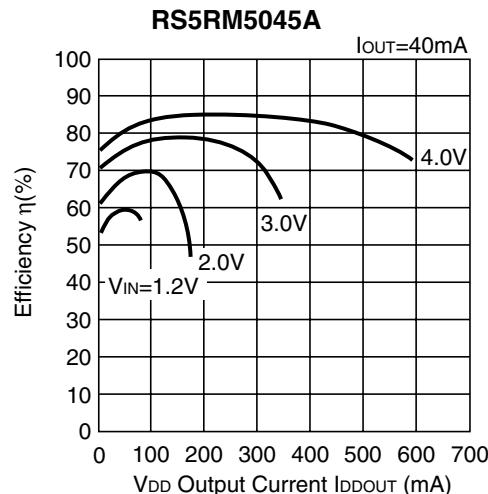
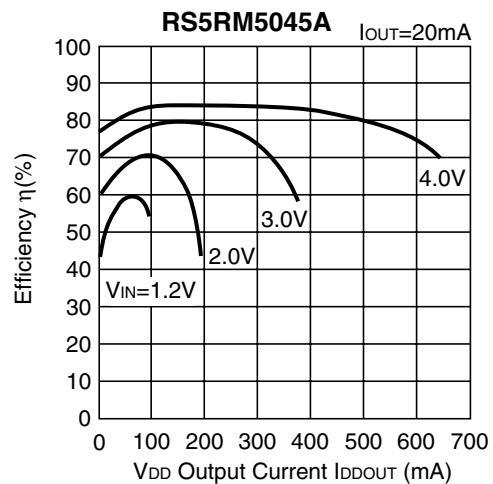
RS5RM5045A**RS5RM5045A****RS5RM5045A**

RS5RM5045A**RS5RM5045A****RS5RM5045A**

19) Output Voltage vs. VDD Output Current

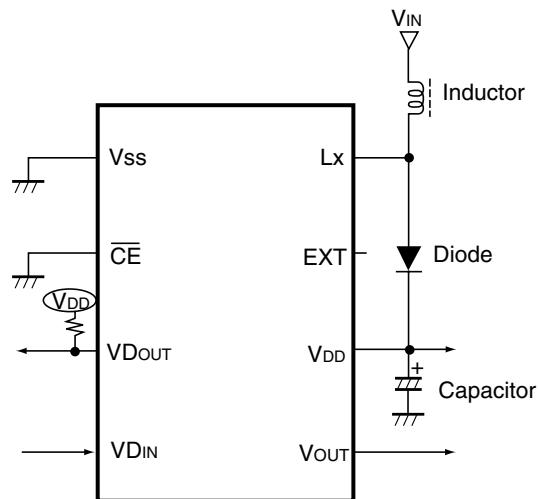


20) Efficiency vs. VDD Output Current



(NOTE) Efficiency η at Typical Characteristics 20) is shown by the following formula: $\eta = \frac{(V_{DD} \times I_{DDOUT}) + (V_{OUT} \times I_{OUT})}{V_{IN} \times I_{IN}} \times 100$

BASIC CIRCUIT



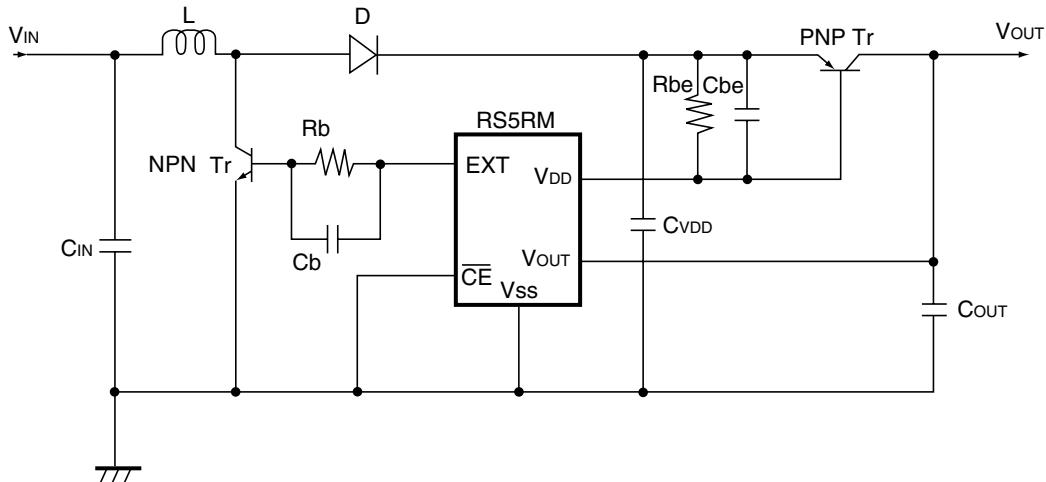
Examples of Parts : Inductor : RCR-664D (100 μ H) ; Sumida Electric Co., Ltd.

Diode : MA721 (Schottky type) ; Matsushita Electronics Corporation

Capacitor : 22 μ F (Tantalum type)

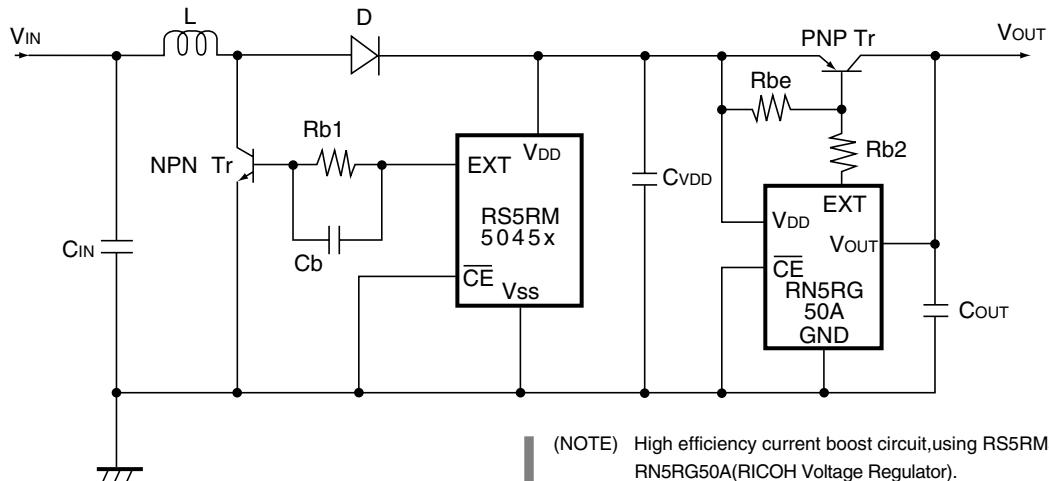
TYPICAL APPLICATIONS

- Current Boost Circuit 1



Examples of Components	L	:47μH(SUMIDA ELECTRIC CD105)	C_D	:0.01μF
	D	:Schottky Diode (HITACHI HRP22)	C_{be}	:0.1μF(RS5RM5045x,RS5RM4036x,RS5RM3624x)
	C_{IN}	:220μF(Aluminum electrolytic Type)		100pF(RS5RM3531x,RS5RM3329x,RS5RM3027x)
	C_{VDD}	:100μF(Tantalum type)/ 220μF(Aluminum electrolytic Type)	NPN Tr	:2SD1628
	C_{OUT}	:47μF(Tantalum Type)	PNP Tr	:2SA1213
			R_b	:220Ω
			R_{be}	:12Ω

- Current Boost Circuit 2 (High Efficiency Circuit)



(NOTE) High efficiency current boost circuit,using RS5RM5045x with RN5RG50A(RICOH Voltage Regulator).

Examples of Components	L	:47μH(SUMIDA ELECTRIC CD105)	C_D	:0.01μF
	D	:Schottky Diode (HITACHI HRP22)	NPN Tr	:2SD1628
	C_{IN}	:220μF(Aluminum electrolytic Type)	PNP Tr	:2SA1213
	C_{VDD}	:33μF(Tantalum type)/ 220μF(Aluminum electrolytic Type)	R_{b1}	:220Ω
	C_{OUT}	:47μF(Tantalum Type)	R_{b2}	:330Ω
			R_{be}	:10kΩ

APPLICATION HINTS

When using these ICs, be sure to take care of the following points:

- Set external components as close as possible to the IC and minimize the connection between the components and the IC. In particular, when an external component is connected to VOUT Pin, make minimum connection with the capacitor.
- Make sufficient grounding. A large current flows through Vss Pin by switching. When the impedance of the Vss connection is high, the potential within the IC is varied by the switching current. This may result in unstable operation of the IC.
- Use capacitor with a capacity of $10\mu F$ or more, and with good high frequency characteristics such as tantalum capacitor. We recommend the use of a capacitor with an allowable voltage which is at least three times the output set voltage. This is because there may be the case where a spike-shaped high voltage is generated by the inductor when Lx transistor is turned OFF.
- Take the utmost care when choosing a inductor. Namely, choose such an inductor that has sufficiently small d.c. resistance and large allowable current, and hardly reaches magnetic saturation. When the inductance value of the inductor is small, there may be the case where ILX exceeds the absolute maximum ratings at the maximum load. Use an inductor with an appropriate inductance.
- Use a diode of a Schottky type with high switching speed, and also take care of the rated current.

The performance of power source circuits using these ICs largely depends upon the peripheral components. Take the utmost care in the selection of the peripheral components. In particular, design the peripheral circuits in such a manner that the values such as voltage, current and power of each component, PCB patterns and the IC do not exceed their respective rated values.